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Power MOSFET

■ GENERAL DESCRIPTION

The XP161A11A1PR-G is an N-channel Power MOSFET with low on-state resistance and ultra high-speed switching characteristics. Because high-speed switching is possible, the IC can be efficiently set thereby saving energy. A gate protect diode is built-in to prevent static damage. The small SOT-89 package makes high density mounting possible.

■ APPLICATIONS

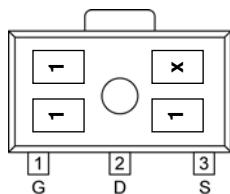
- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

■ FEATURES

Low On-State Resistance : $R_{ds(on)}=0.065\Omega @ V_{gs}=10V$
: $R_{ds(on)}=0.105\Omega @ V_{gs}=4.5V$

Ultra High-Speed Switching
Gate Protect Diode Built-in
Driving Voltage : 4.5V
N-Channel Power MOSFET
DMOS Structure
Small Package : SOT-89
Environmentally Friendly : EU RoHS Compliant, Pb Free

■ PIN CONFIGURATION/MARKING

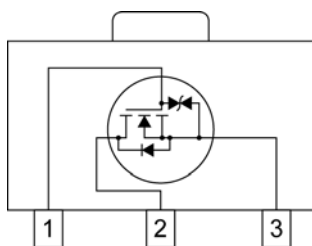


G : Gate
S : Source
D : Drain

SOT-89
(TOP VIEW)

* x represents production lot number.

■ EQUIVALENT CIRCUIT



N-channel MOSFET
(1 device built-in)

■ PRODUCT NAME

PRODUCTS	PACKAGE	ORDER UNIT
XP161A11A1PR	SOT-89	1,000/Reel
XP161A11A1PR-G ^(*)	SOT-89	1,000/Reel

^(*) The "-G" suffix denotes Halogen and Antimony free as well as being fully RoHS compliant.

■ ABSOLUTE MAXIMUM RATINGS

Ta = 25°C

PARAMETER	SYMBOL	RATINGS	UNITS
Drain - Source Voltage	V _{dss}	30	V
Gate - Source Voltage	V _{gss}	±20	V
Drain Current (DC)	I _d	4	A
Drain Current (Pulse)	I _{dp}	16	A
Reverse Drain Current	I _{dr}	4	A
Channel Power Dissipation *	P _d	2	W
Channel Temperature	T _{ch}	150	°C
Storage Temperature	T _{stg}	-55~150	°C

* When implemented on a ceramic PCB

ELECTRICAL CHARACTERISTICS

DC Characteristics

Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain Cut-Off Current	I _{dss}	V _{ds} =30V, V _{gs} = 0V	-	-	10	μA
Gate-Source Leak Current	I _{gss}	V _{gs} = ±20V, V _{ds} = 0V	-	-	±10	μA
Gate-Source Cut-Off Voltage	V _{gs(off)}	I _d = 1mA, V _{ds} = 10V	1.0	-	2.5	V
Drain-Source On-State Resistance*1	R _{ds(on)}	I _d = 2A, V _{gs} = 10V	-	0.05	0.065	Ω
		I _d = 2A, V _{gs} = 4.5V	-	0.075	0.105	Ω
Forward Transfer Admittance *1	Y _{fs}	I _d = 2A, V _{ds} = 10V	-	5.5	-	S
Body Drain Diode Forward Voltage	V _f	I _f = 4A, V _{gs} = 0V	-	0.85	1.1	V

*1 Effective during pulse test.

Dynamic Characteristics

Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Capacitance	C _{iss}	V _{ds} = 10V, V _{gs} =0V f= 1MHz	-	270	-	pF
Output Capacitance	C _{oss}		-	150	-	pF
Feedback Capacitance	C _{rss}		-	55	-	pF

Switching Characteristics

Ta = 25°C

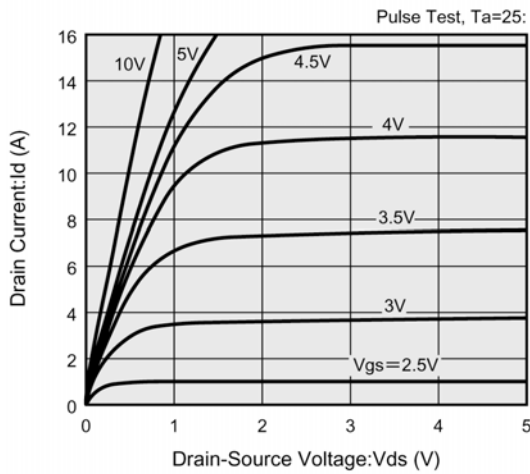
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	t _{d (on)}	V _{gs} = 5V, I _d =2A V _{dd} = 10V	-	10	-	ns
Rise Time	t _r		-	15	-	ns
Turn-Off Delay Time	t _{d (off)}		-	35	-	ns
Fall Time	t _f		-	15	-	ns

Thermal Characteristics

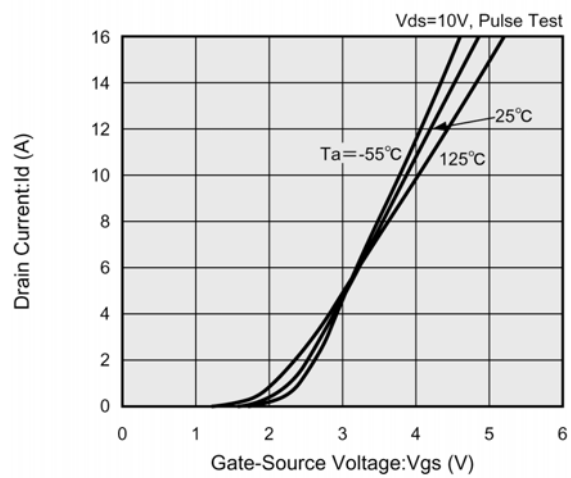
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal Resistance (Channel-Ambience)	R _{th (ch-a)}	Implement on a ceramic PCB	-	62.5	-	°C/W

TYPICAL PERFORMANCE CHARACTERISTICS

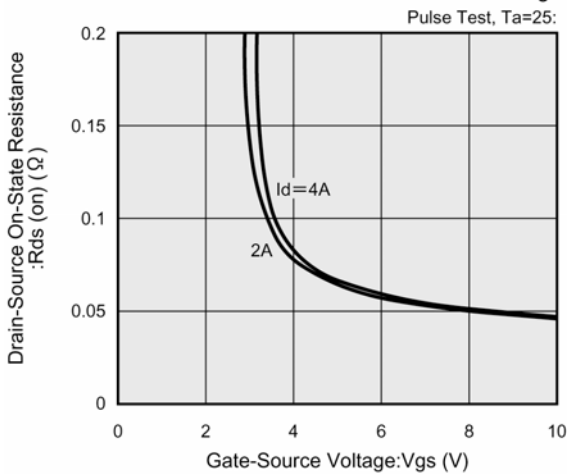
(1) Drain Current vs. Drain-Source Voltage



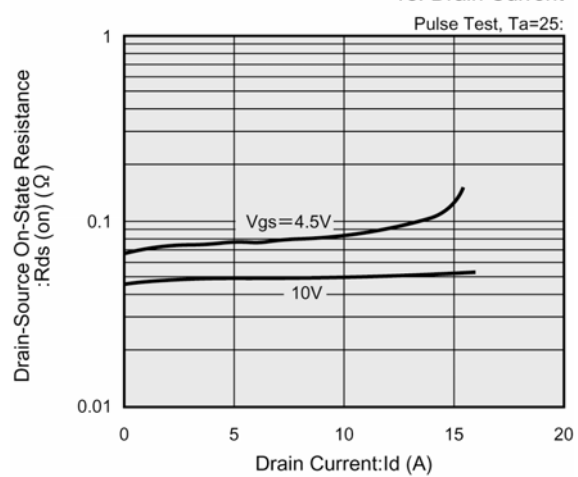
(2) Drain Current vs. Gate-Source Voltage



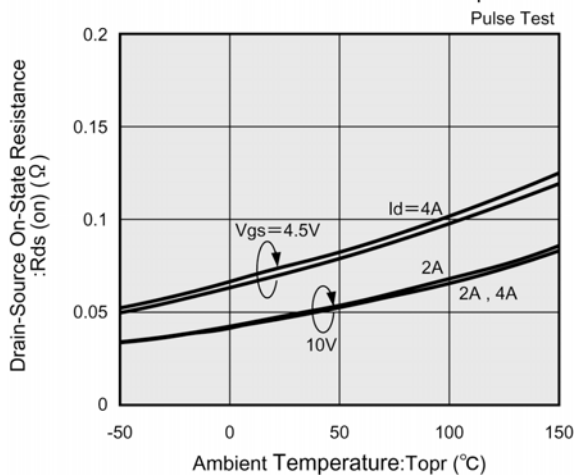
(3) Drain-Source On-State Resistance vs. Gate-Source Voltage



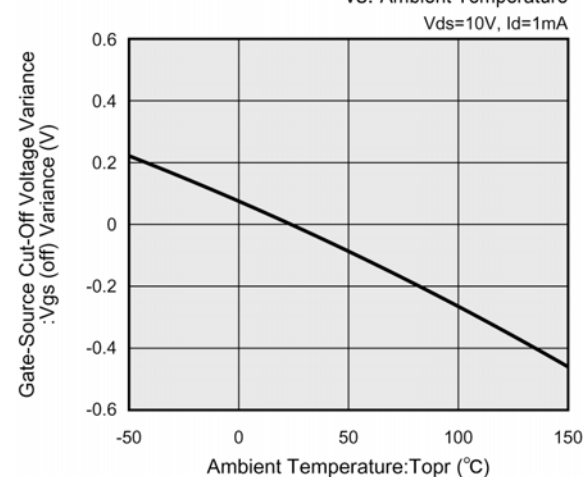
(4) Drain-Source On-State Resistance vs. Drain Current



(5) Drain-Source On-State Resistance vs. Ambient Temperature

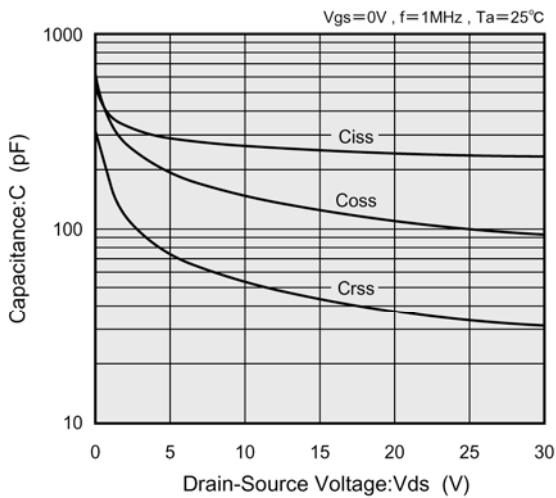


(6) Gate-Source Cut-Off Voltage Variance vs. Ambient Temperature

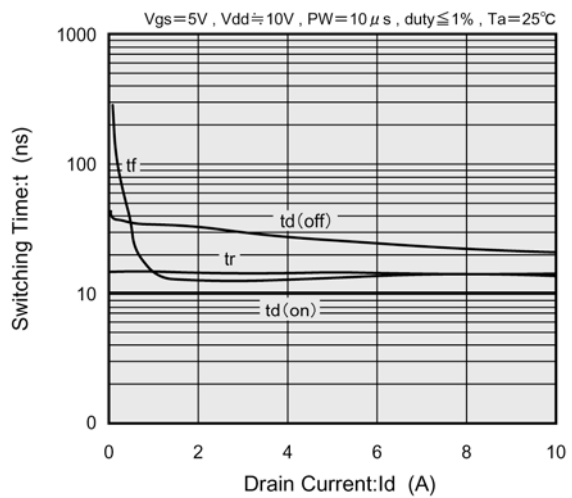


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

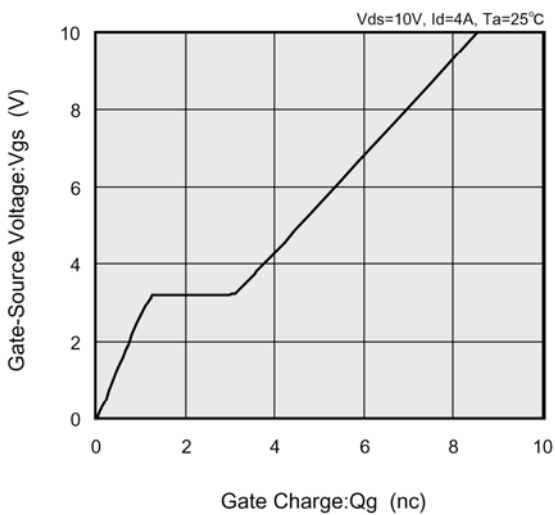
(7) Capacitance vs. Drain-Source Voltage



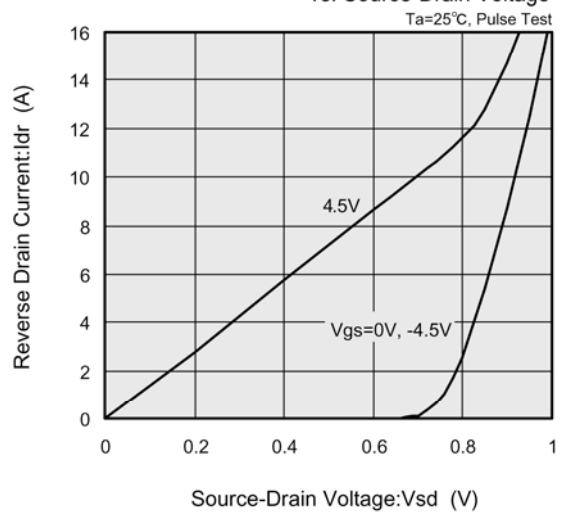
(8) Switching Time vs. Drain Current



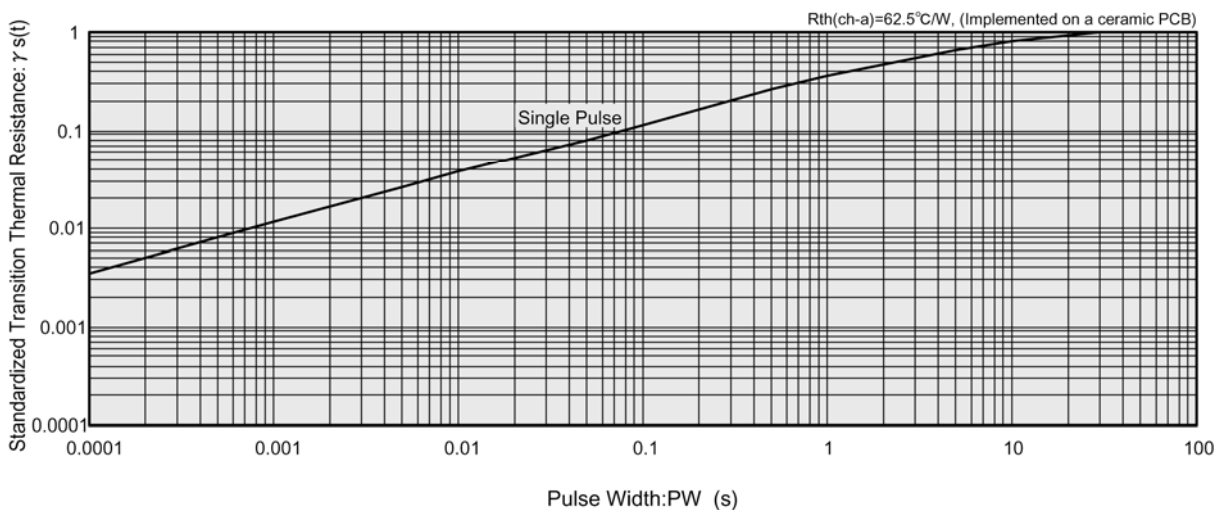
(9) Gate-Source Voltage vs. Gate Charge



(10) Reverse Drain Current vs. Source-Drain Voltage



(11) Standardized transition Thermal Resistance vs. Pulse Width



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